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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

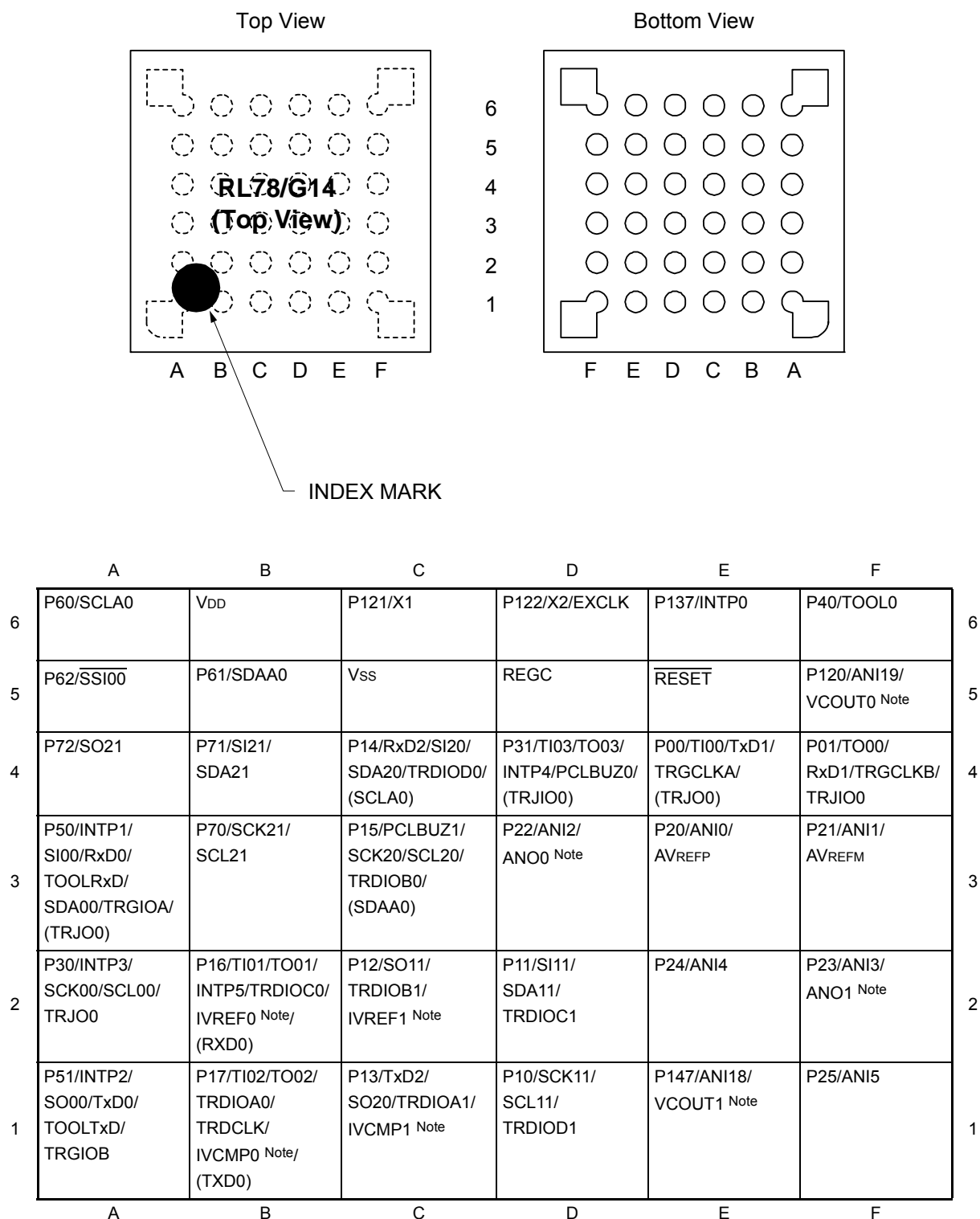
### Applications of "[Embedded - Microcontrollers](#)"

#### Details

|                            |   |
|----------------------------|---|
| Product Status             | Active  |
| Core Processor             | RL78  |
| Core Size                  | 16-Bit  |
| Speed                      | 32MHz   |
| Connectivity               | CSI, I <sup>2</sup> C, LINbus, UART/USART   |
| Peripherals                | DMA, LVD, POR, PWM, WDT   |
| Number of I/O              | 34  |
| Program Memory Size        | 64KB (64K x 8)  |
| Program Memory Type        | FLASH   |
| EEPROM Size                | 4K x 8  |
| RAM Size                   | 5.5K x 8  |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 5.5V   |
| Data Converters            | A/D 10x8/10b  |
| Oscillator Type            | Internal  |
| Operating Temperature      | -40°C ~ 85°C (TA)   |
| Mounting Type              | Surface Mount   |
| Package / Case             | 48-LQFP   |
| Supplier Device Package    | 48-LFQFP (7x7)  |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f104gedfb-50">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f104gedfb-50</a> |

### 1.3.3 36-pin products

- 36-pin plastic WFLGA (4 × 4 mm, 0.5 mm pitch)



**Note** Mounted on the 96 KB or more code flash memory products.

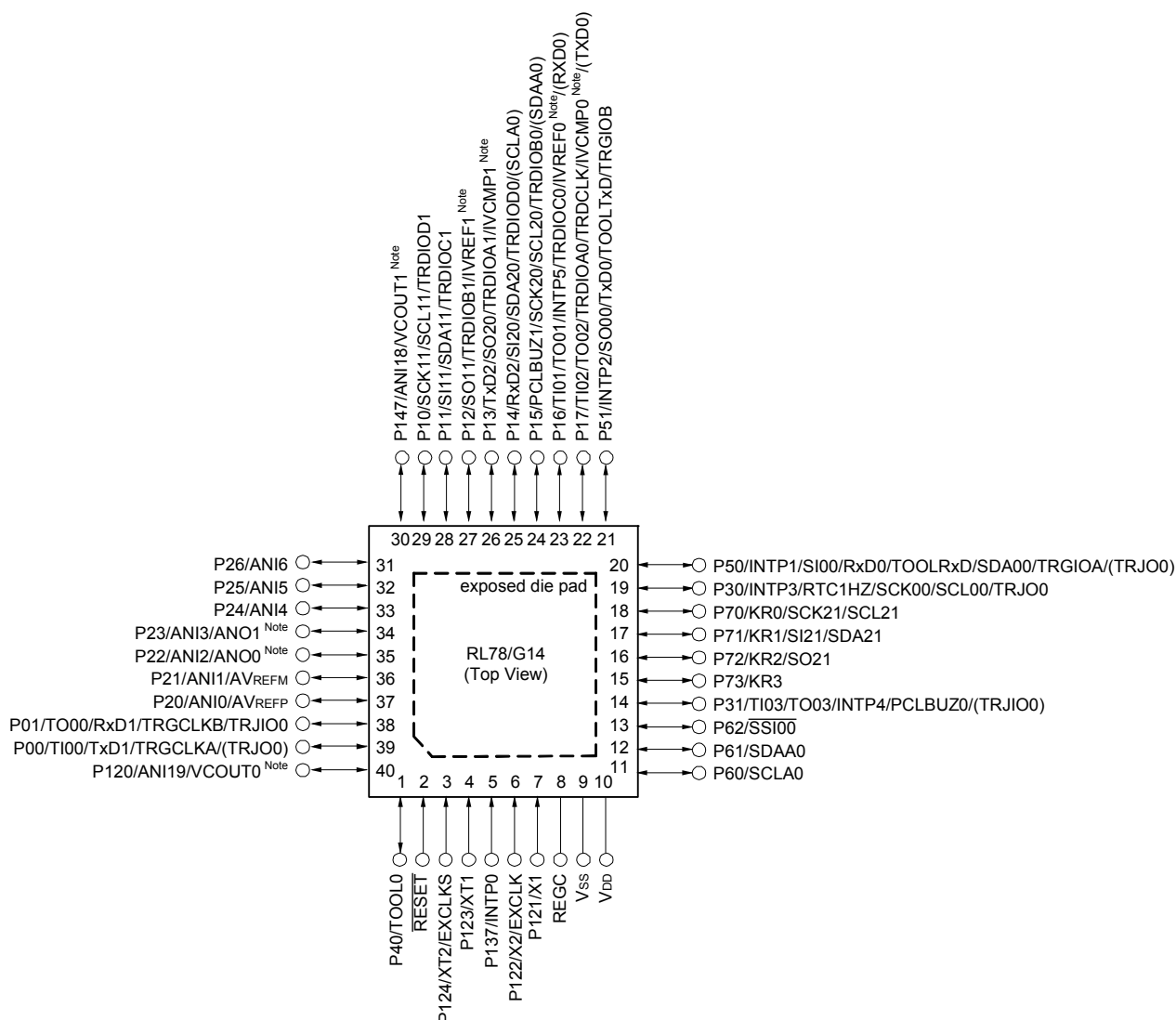
**Caution** Connect the REGC pin to V<sub>SS</sub> pin via a capacitor (0.47 to 1  $\mu$ F).

**Remark 1.** For pin identification, see 1.4 Pin Identification.

**Remark 2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register 0, 1 (PIOR0, 1).

### 1.3.4 40-pin products

- 40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)



**Note** Mounted on the 96 KB or more code flash memory products.

**Caution** Connect the REGC pin to V<sub>SS</sub> pin via a capacitor (0.47 to 1 μF).

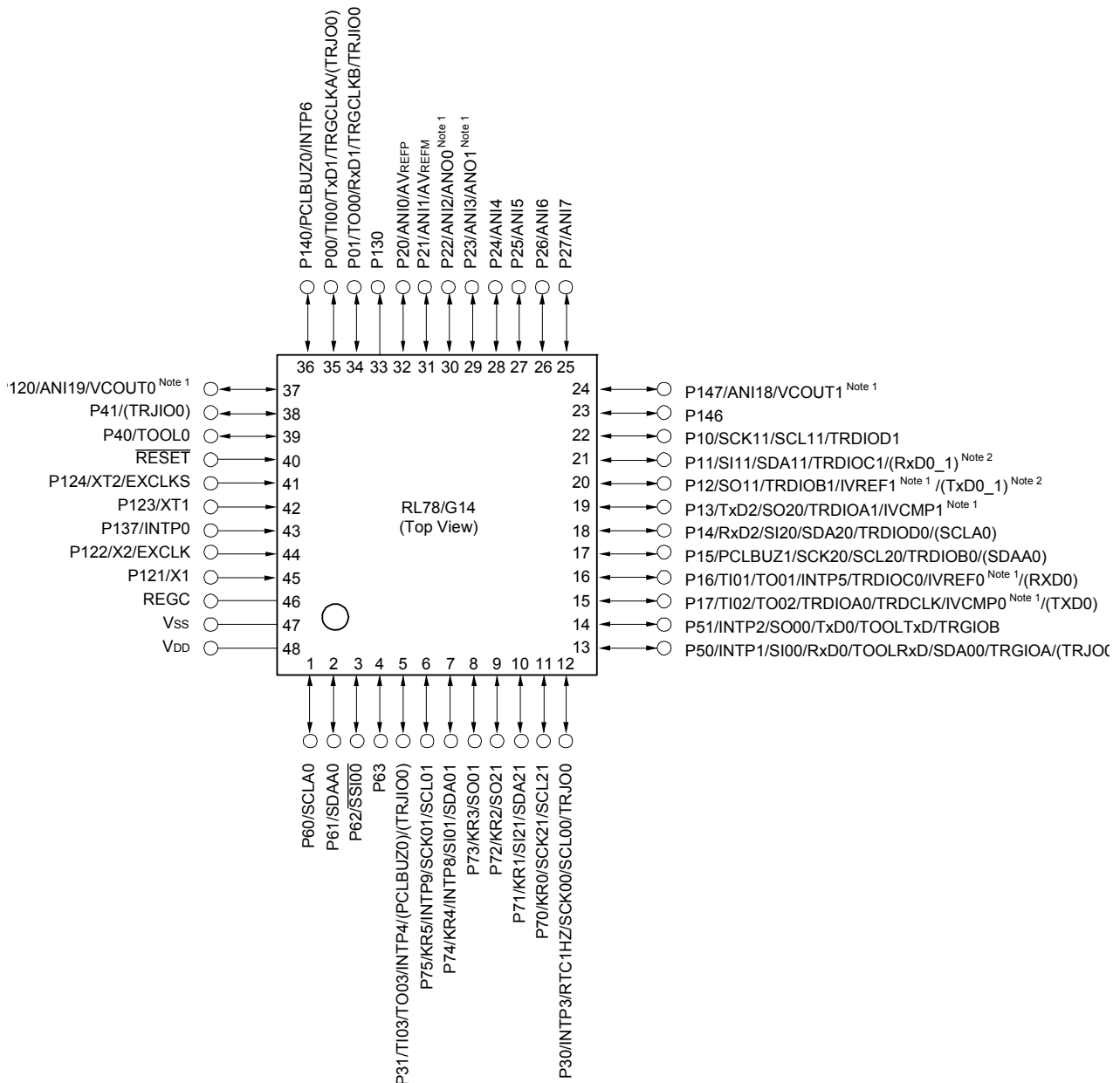
**Remark 1.** For pin identification, see 1.4 Pin Identification.

**Remark 2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register 0, 1 (PIOR0, 1).

**Remark 3.** It is recommended to connect an exposed die pad to V<sub>SS</sub>.

### 1.3.6 48-pin products

- 48-pin plastic LFQFP (7 × 7 mm, 0.5 mm pitch)



**Note 1.** Mounted on the 96 KB or more code flash memory products.

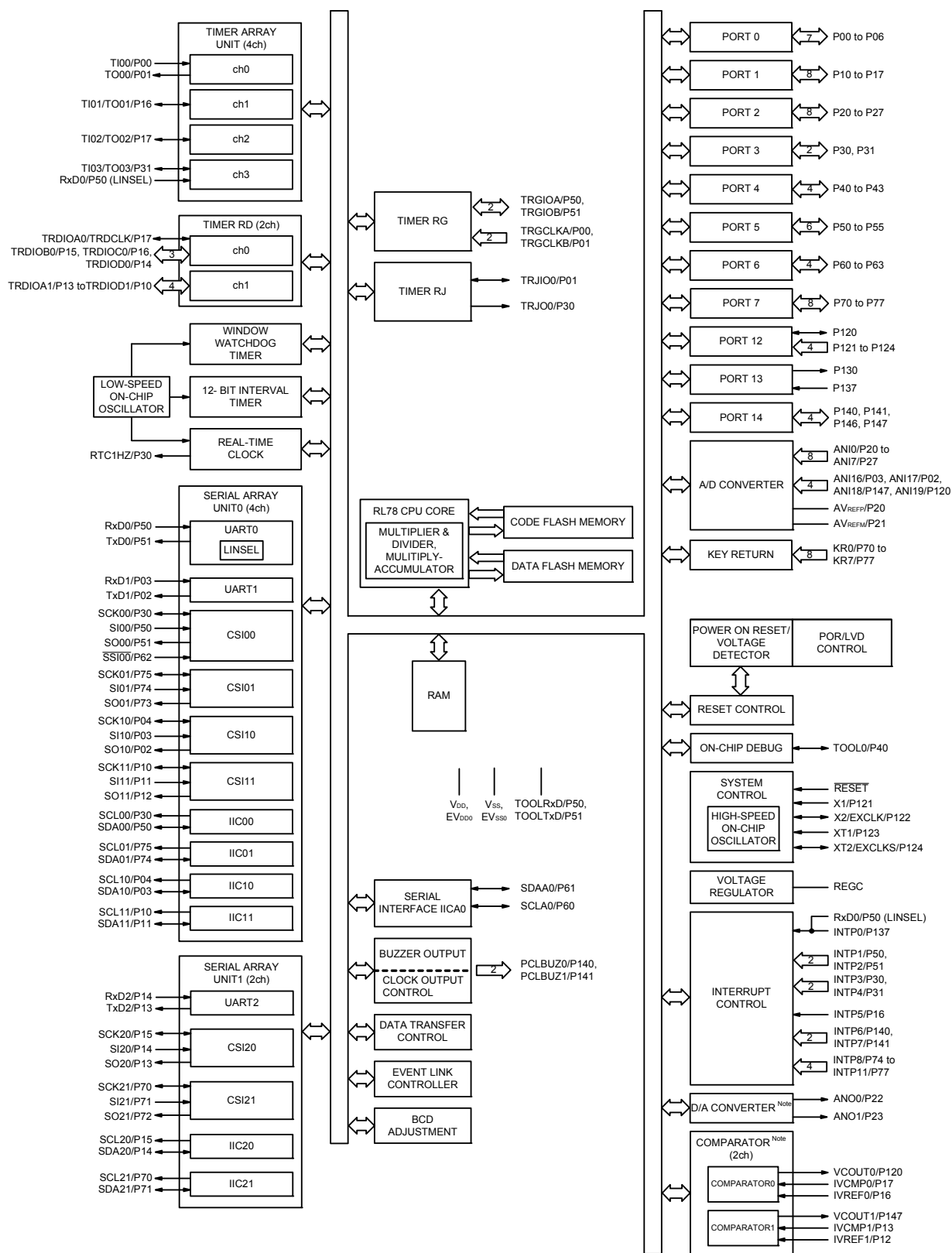
**Note 2.** Mounted on the 384 KB or more code flash memory products.

**Caution** Connect the REGC pin to Vss pin via a capacitor (0.47 to 1 μF).

**Remark 1.** For pin identification, see 1.4 Pin Identification.

**Remark 2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register 0, 1 (PIOR0, 1).

## 1.5.8 64-pin products



**Note** Mounted on the 96 KB or more code flash memory products.

[30-pin, 32-pin, 36-pin, 40-pin products (code flash memory 96 KB to 256 KB)]

**Caution** This outline describes the functions at the time when Peripheral I/O redirection register 0, 1 (PIOR0, 1) are set to 00H.

(1/2)

| Item                               |  | 30-pin   | 32-pin                 | 36-pin                 | 40-pin   |
|------------------------------------|--|--|------------------------|------------------------|--|
|                                    |  | R5F104Ax<br>(x = F, G)   | R5F104Bx<br>(x = F, G) | R5F104Cx<br>(x = F, G) | R5F104Ex<br>(x = F to H)   |
| Code flash memory (KB)             |  | 96 to 128  | 96 to 128              | 96 to 128              | 96 to 192  |
| Data flash memory (KB)             |  | 8  | 8                      | 8                      | 8  |
| RAM (KB)                           |  | 12 to 16 Note  | 12 to 16 Note          | 12 to 16 Note          | 12 to 20 Note  |
| Address space                      |  | 1 MB   |                        |                        |  |
| Main system clock                  | High-speed system clock                          | X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK)<br>HS (high-speed main) mode: 1 to 20 MHz ( $V_{DD} = 2.7$ to $5.5$ V),<br>HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to $5.5$ V),<br>LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to $5.5$ V),<br>LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to $5.5$ V)  |                        |                        |  |
|                                    | High-speed on-chip oscillator clock ( $f_{IH}$ ) | HS (high-speed main) mode: 1 to 32 MHz ( $V_{DD} = 2.7$ to $5.5$ V),<br>HS (high-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to $5.5$ V),<br>LS (low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to $5.5$ V),<br>LV (low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to $5.5$ V)  |                        |                        |  |
| Subsystem clock                    |  | —  |                        |                        | XT1 (crystal) oscillation, external subsystem clock input (EXCLKS)<br>32.768 kHz |
| Low-speed on-chip oscillator clock |  | 15 kHz (TYP.): $V_{DD} = 1.6$ to $5.5$ V   |                        |                        |  |
| General-purpose register           |  | 8 bits $\times$ 32 registers (8 bits $\times$ 8 registers $\times$ 4 banks)  |                        |                        |  |
| Minimum instruction execution time |  | 0.03125 $\mu$ s (High-speed on-chip oscillator clock: $f_{IH} = 32$ MHz operation)   |                        |                        |  |
|                                    |  | 0.05 $\mu$ s (High-speed system clock: $f_{MX} = 20$ MHz operation)  |                        |                        |  |
|                                    |  | —  |                        |                        | 30.5 $\mu$ s (Subsystem clock: $f_{SUB} = 32.768$ kHz operation)                 |
| Instruction set                    |  | <ul style="list-style-type: none"> <li>• Data transfer (8/16 bits)</li> <li>• Adder and subtractor/logical operation (8/16 bits)</li> <li>• Multiplication (8 bits <math>\times</math> 8 bits, 16 bits <math>\times</math> 16 bits), Division (16 bits <math>\div</math> 16 bits, 32 bits <math>\div</math> 32 bits)</li> <li>• Multiplication and Accumulation (16 bits <math>\times</math> 16 bits + 32 bits)</li> <li>• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li> </ul> |                        |                        |  |
| I/O port                           | Total  | 26   | 28                     | 32                     | 36   |
|                                    | CMOS I/O   | 21   | 22                     | 26                     | 28   |
|                                    | CMOS input                                       | 3  | 3                      | 3                      | 5  |
|                                    | CMOS output                                      | —  | —                      | —                      | —  |
|                                    | N-ch open-drain I/O (6 V tolerance)              | 2  | 3                      | 3                      | 3  |
| Timer                              | 16-bit timer                                     | 8 channels<br>(TAU: 4 channels, Timer RJ: 1 channel, Timer RD: 2 channels, Timer RG: 1 channel)  |                        |                        |  |
|                                    | Watchdog timer                                   | 1 channel  |                        |                        |  |
|                                    | Real-time clock (RTC)                            | 1 channel  |                        |                        |  |
|                                    | 12-bit interval timer                            | 1 channel  |                        |                        |  |
|                                    | Timer output                                     | Timer outputs: 13 channels<br>PWM outputs: 9 channels  |                        |                        |  |
|                                    | RTC output                                       | —  |                        |                        | 1<br>• 1 Hz<br>(subsystem clock: $f_{SUB} = 32.768$ kHz)                         |

(Note is listed on the next page.)

**Absolute Maximum Ratings****(2/2)**

| Parameter                     | Symbols | Conditions                       |  | Ratings     | Unit |
|-------------------------------|---------|----------------------------------|--|-------------|------|
| Output current, high          | IOH1    | Per pin                          | P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147 | -40         | mA   |
|                               |         | Total of all pins<br>-170 mA     | P00 to P04, P40 to P47, P102, P120, P130, P140 to P145   | -70         | mA   |
|                               |         |                                  | P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100, P101, P110, P111, P146, P147                               | -100        | mA   |
|                               | IOH2    | Per pin                          | P20 to P27, P150 to P156   | -0.5        | mA   |
|                               |         | Total of all pins                |  | -2          | mA   |
| Output current, low           | IOL1    | Per pin                          | P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147 | 40          | mA   |
|                               |         | Total of all pins<br>170 mA      | P00 to P04, P40 to P47, P102, P120, P130, P140 to P145   | 70          | mA   |
|                               |         |                                  | P05, P06, P10 to P17, P30, P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P100, P101, P110, P111, P146, P147                               | 100         | mA   |
|                               | IOL2    | Per pin                          | P20 to P27, P150 to P156   | 1           | mA   |
|                               |         | Total of all pins                |  | 5           | mA   |
| Operating ambient temperature | TA      | In normal operation mode         |  | -40 to +85  | °C   |
|                               |         | In flash memory programming mode |  |             |      |
| Storage temperature           | Tstg    |                                  |  | -65 to +150 | °C   |

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

- Note 1.** Total current flowing into VDD, EVDD0, and EVDD1, including the input leakage current flowing when the level of the input pin is fixed to VDD, EVDD0, and EVDD1, or VSS, EVSS0, and EVSS1. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, D/A converter, comparator, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
- Note 2.** When high-speed on-chip oscillator and subsystem clock are stopped.
- Note 3.** When high-speed system clock and subsystem clock are stopped.
- Note 4.** When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the 12-bit interval timer and watchdog timer.
- Note 5.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
- |                             |                                     |
|-----------------------------|-------------------------------------|
| HS (high-speed main) mode:  | 2.7 V ≤ VDD ≤ 5.5 V@1 MHz to 32 MHz |
|                             | 2.4 V ≤ VDD ≤ 5.5 V@1 MHz to 16 MHz |
| LS (low-speed main) mode:   | 1.8 V ≤ VDD ≤ 5.5 V@1 MHz to 8 MHz  |
| LV (low-voltage main) mode: | 1.6 V ≤ VDD ≤ 5.5 V@1 MHz to 4 MHz  |
- Remark 1.** fMX: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
- Remark 2.** fHOCO: High-speed on-chip oscillator clock frequency (64 MHz max.)
- Remark 3.** fIH: High-speed on-chip oscillator clock frequency (32 MHz max.)
- Remark 4.** fSUB: Subsystem clock frequency (XT1 clock oscillation frequency)
- Remark 5.** Except subsystem clock operation, temperature condition of the TYP. value is TA = 25°C



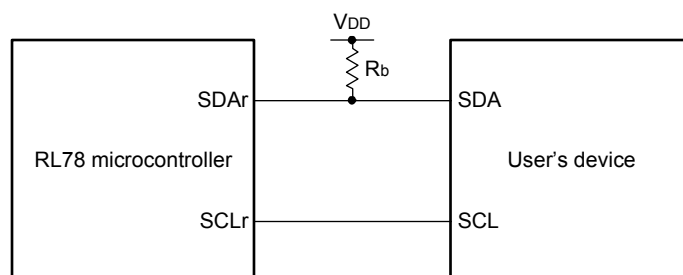
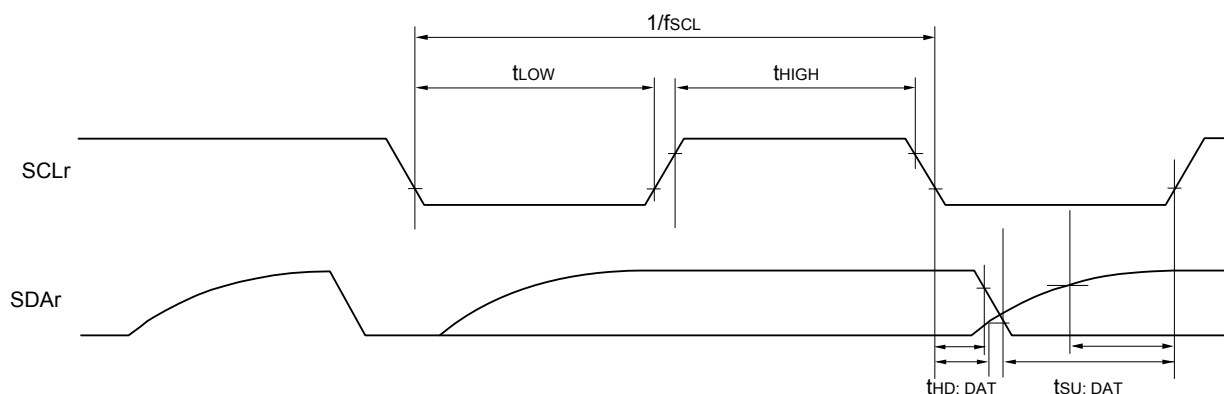
- Note 5.** Current flowing only to the watchdog timer (including the operating current of the low-speed on-chip oscillator). The supply current of the RL78 microcontrollers is the sum of I<sub>DD1</sub>, I<sub>DD2</sub> or I<sub>DD3</sub> and I<sub>WDT</sub> when the watchdog timer is in operation.
- Note 6.** Current flowing only to the A/D converter. The supply current of the RL78 microcontrollers is the sum of I<sub>DD1</sub> or I<sub>DD2</sub> and I<sub>ADC</sub> when the A/D converter operates in an operation mode or the HALT mode.
- Note 7.** Current flowing only to the LVD circuit. The supply current of the RL78 microcontrollers is the sum of I<sub>DD1</sub>, I<sub>DD2</sub> or I<sub>DD3</sub> and I<sub>LVD</sub> when the LVD circuit is in operation.
- Note 8.** Current flowing during programming of the data flash.
- Note 9.** Current flowing during self-programming.
- Note 10.** For shift time to the SNOOZE mode, see **23.3.3 SNOOZE mode** in the RL78/G14 User's Manual.
- Note 11.** Current flowing only to the D/A converter. The supply current of the RL78 microcontrollers is the sum of I<sub>DD1</sub> or I<sub>DD2</sub> and I<sub>DAC</sub> when the D/A converter operates in an operation mode or the HALT mode.
- Note 12.** Current flowing only to the comparator circuit. The supply current of the RL78 microcontrollers is the sum of I<sub>DD1</sub>, I<sub>DD2</sub>, or I<sub>DD3</sub> and I<sub>CMP</sub> when the comparator circuit is in operation.
- Note 13.** A comparator and D/A converter are provided in products with 96 KB or more code flash memory.

**Remark 1.** f<sub>IL</sub>: Low-speed on-chip oscillator clock frequency

**Remark 2.** f<sub>SUB</sub>: Subsystem clock frequency (XT1 clock oscillation frequency)

**Remark 3.** f<sub>CLK</sub>: CPU/peripheral hardware clock frequency

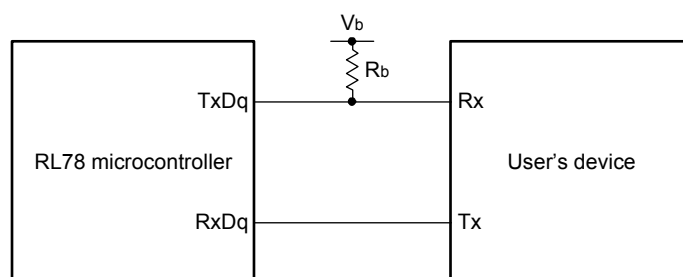
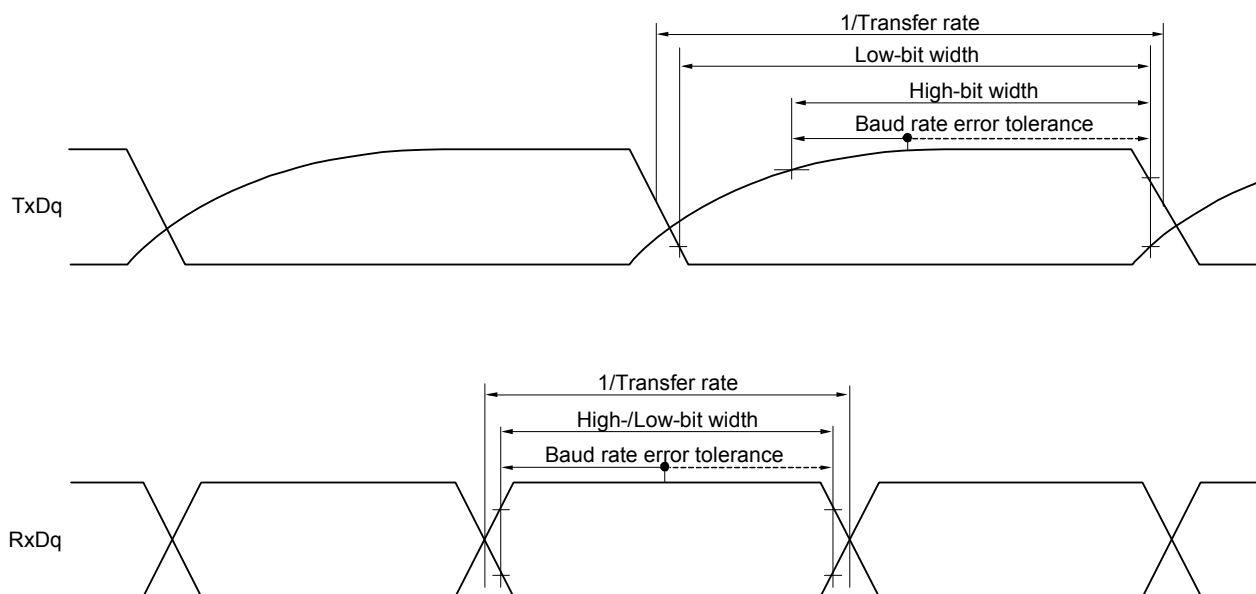
**Remark 4.** Temperature condition of the TYP. value is T<sub>A</sub> = 25°C

**Simplified I<sup>2</sup>C mode connection diagram (during communication at same potential)****Simplified I<sup>2</sup>C mode serial transfer timing (during communication at same potential)**

**Remark 1.**  $R_b[\Omega]$ : Communication line (SDAr) pull-up resistance,  $C_b[F]$ : Communication line (SDAr, SCLr) load capacitance

**Remark 2.** r: IIC number (r = 00, 01, 10, 11, 20, 21, 30, 31), g: PIM number (g = 0, 1, 3 to 5, 14),  
h: POM number (h = 0, 1, 3 to 5, 7, 14)

**Remark 3.**  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number (m = 0, 1),  
n: Channel number (n = 0 to 3), mn = 00 to 03, 10 to 13)

**UART mode connection diagram (during communication at different potential)****UART mode bit width (during communication at different potential) (reference)**

**Remark 1.** R<sub>b</sub>[Ω]: Communication line (TxDq) pull-up resistance,

C<sub>b</sub>[F]: Communication line (TxDq) load capacitance, V<sub>b</sub>[V]: Communication line voltage

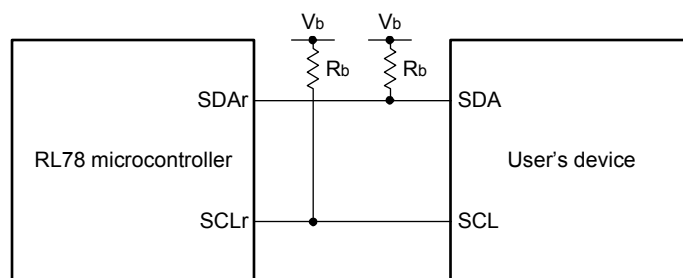
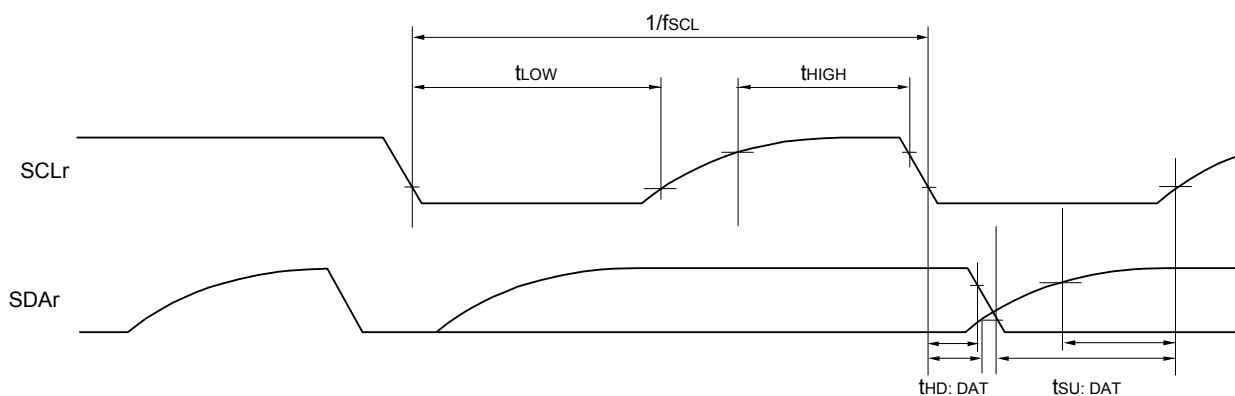
**Remark 2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 5, 14)

**Remark 3.** f<sub>MCK</sub>: Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).

m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

**Remark 4.** UART2 cannot communicate at different potential when bit 1 (PIOR01) of peripheral I/O redirection register 0 (PIOR0) is 1.

**Simplified I<sup>2</sup>C mode connection diagram (during communication at different potential)****Simplified I<sup>2</sup>C mode serial transfer timing (during communication at different potential)**

**Remark 1.**  $R_b[\Omega]$ : Communication line (SDAr, SCLr) pull-up resistance,  $C_b[F]$ : Communication line (SDAr, SCLr) load capacitance,  $V_b[V]$ : Communication line voltage

**Remark 2.**  $r$ : IIC number ( $r = 00, 01, 10, 11, 20, 30, 31$ ),  $g$ : PIM, POM number ( $g = 0, 1, 3$  to  $5, 14$ )

**Remark 3.**  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).  $m$ : Unit number ( $m = 0, 1$ ),  
 $n$ : Channel number ( $n = 0, 2$ ),  $mn = 00, 01, 02, 10, 12, 13$ )

### 3.3 DC Characteristics

#### 3.3.1 Pin characteristics

(TA = -40 to +105°C, 2.4 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

| Items                                  | Symbol | Conditions  | MIN.                  | TYP. | MAX.                      | Unit |
|--|--------|---|-----------------------|------|---------------------------|------|
| Output current, high <sup>Note 1</sup> | IOH1   | Per pin for P00 to P06,<br>P10 to P17, P30, P31,<br>P40 to P47, P50 to P57,<br>P64 to P67, P70 to P77,<br>P80 to P87, P100 to P102, P110,<br>P111, P120, P130, P140 to P147     | 2.4 V ≤ EVDD0 ≤ 5.5 V |      | -3.0<br><sup>Note 2</sup> | mA   |
|  |        | Total of P00 to P04, P40 to P47,<br>P102, P120, P130, P140 to P145<br>(When duty ≤ 70% <sup>Note 3</sup> )  | 4.0 V ≤ EVDD0 ≤ 5.5 V |      | -30.0                     | mA   |
|  |        |   | 2.7 V ≤ EVDD0 < 4.0 V |      | -10.0                     | mA   |
|  |        |   | 2.4 V ≤ EVDD0 < 2.7 V |      | -5.0                      | mA   |
|  |        | Total of P05, P06, P10 to P17,<br>P30, P31, P50 to P57,<br>P64 to P67, P70 to P77,<br>P80 to P87, P100, P101, P110,<br>P111, P146, P147<br>(When duty ≤ 70% <sup>Note 3</sup> ) | 4.0 V ≤ EVDD0 ≤ 5.5 V |      | -30.0                     | mA   |
|  |        |   | 2.7 V ≤ EVDD0 < 4.0 V |      | -19.0                     | mA   |
|  |        |   | 2.4 V ≤ EVDD0 < 2.7 V |      | -10.0                     | mA   |
|  |        | Total of all pins<br>(When duty ≤ 70% <sup>Note 3</sup> )   | 2.4 V ≤ EVDD0 ≤ 5.5 V |      | -60.0                     | mA   |
|  | IOH2   | Per pin for P20 to P27,<br>P150 to P156   | 2.4 V ≤ VDD ≤ 5.5 V   |      | -0.1<br><sup>Note 2</sup> | mA   |
|  |        | Total of all pins<br>(When duty ≤ 70% <sup>Note 3</sup> )   | 2.4 V ≤ VDD ≤ 5.5 V   |      | -1.5                      | mA   |

**Note 1.** Value of current at which the device operation is guaranteed even if the current flows from the EVDD0, EVDD1, VDD pins to an output pin.

**Note 2.** Do not exceed the total current value.

**Note 3.** Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (IOH × 0.7)/(n × 0.01)  
 <Example> Where n = 80% and IOH = -10.0 mA  
 Total output current of pins = (-10.0 × 0.7)/(80 × 0.01) ≈ -8.7 mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor.

A current higher than the absolute maximum rating must not flow into one pin.

**Caution** P00, P02 to P04, P10, P11, P13 to P15, P17, P30, P43 to P45, P50 to P55, P71, P74, P80 to P82, and P142 to P144 do not output high level in N-ch open-drain mode.

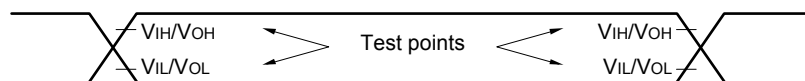
**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

**(3) Flash ROM: 384 to 512 KB of 48- to 100-pin products****(TA = -40 to +105°C, 2.4 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)**

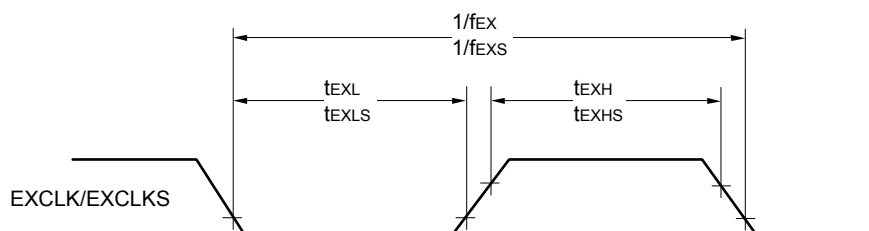
| Parameter                | Symbol           | Conditions     |                                  |   |                  |                         | MIN. | TYP. | MAX. | Unit |
|--------------------------|------------------|----------------|----------------------------------|---|------------------|-------------------------|------|------|------|------|
| Supply current<br>Note 1 | I <sub>DD1</sub> | Operating mode | HS (high-speed main) mode Note 5 | f <sub>HOCO</sub> = 64 MHz,<br>f <sub>IIH</sub> = 32 MHz Note 3 | Basic operation  | V <sub>DD</sub> = 5.0 V |      | 2.9  |      | mA   |
|                          |                  |                |                                  |   |                  | V <sub>DD</sub> = 3.0 V |      | 2.9  |      |      |
|                          |                  |                |                                  | f <sub>HOCO</sub> = 32 MHz,<br>f <sub>IIH</sub> = 32 MHz Note 3 | Basic operation  | V <sub>DD</sub> = 5.0 V |      | 2.5  |      |      |
|                          |                  |                |                                  |   |                  | V <sub>DD</sub> = 3.0 V |      | 2.5  |      |      |
|                          |                  |                | HS (high-speed main) mode Note 5 | f <sub>HOCO</sub> = 64 MHz,<br>f <sub>IIH</sub> = 32 MHz Note 3 | Normal operation | V <sub>DD</sub> = 5.0 V |      | 6.0  | 11.2 | mA   |
|                          |                  |                |                                  |   |                  | V <sub>DD</sub> = 3.0 V |      | 6.0  | 11.2 |      |
|                          |                  |                |                                  | f <sub>HOCO</sub> = 32 MHz,<br>f <sub>IIH</sub> = 32 MHz Note 3 | Normal operation | V <sub>DD</sub> = 5.0 V |      | 5.5  | 10.6 |      |
|                          |                  |                |                                  |   |                  | V <sub>DD</sub> = 3.0 V |      | 5.5  | 10.6 |      |
|                          |                  |                |                                  | f <sub>HOCO</sub> = 48 MHz,<br>f <sub>IIH</sub> = 24 MHz Note 3 | Normal operation | V <sub>DD</sub> = 5.0 V |      | 4.7  | 8.6  |      |
|                          |                  |                |                                  |   |                  | V <sub>DD</sub> = 3.0 V |      | 4.7  | 8.6  |      |
|                          |                  |                |                                  | f <sub>HOCO</sub> = 24 MHz,<br>f <sub>IIH</sub> = 24 MHz Note 3 | Normal operation | V <sub>DD</sub> = 5.0 V |      | 4.4  | 8.2  |      |
|                          |                  |                |                                  |   |                  | V <sub>DD</sub> = 3.0 V |      | 4.4  | 8.2  |      |
|                          |                  |                |                                  | f <sub>HOCO</sub> = 16 MHz,<br>f <sub>IIH</sub> = 16 MHz Note 3 | Normal operation | V <sub>DD</sub> = 5.0 V |      | 3.3  | 5.9  |      |
|                          |                  |                |                                  |   |                  | V <sub>DD</sub> = 3.0 V |      | 3.3  | 5.9  |      |
|                          |                  |                | HS (high-speed main) mode Note 5 | f <sub>MX</sub> = 20 MHz Note 2,<br>V <sub>DD</sub> = 5.0 V     | Normal operation | Square wave input       |      | 3.7  | 6.8  | mA   |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 3.9  | 7.0  |      |
|                          |                  |                |                                  | f <sub>MX</sub> = 20 MHz Note 2,<br>V <sub>DD</sub> = 3.0 V     | Normal operation | Square wave input       |      | 3.7  | 6.8  |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 3.9  | 7.0  |      |
|                          |                  |                |                                  | f <sub>MX</sub> = 10 MHz Note 2,<br>V <sub>DD</sub> = 5.0 V     | Normal operation | Square wave input       |      | 2.3  | 4.1  |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 2.3  | 4.2  |      |
|                          |                  |                |                                  | f <sub>MX</sub> = 10 MHz Note 2,<br>V <sub>DD</sub> = 3.0 V     | Normal operation | Square wave input       |      | 2.3  | 4.1  |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 2.3  | 4.2  |      |
|                          |                  |                | Subsystem clock operation        | f <sub>SUB</sub> = 32.768 kHz Note 4<br>TA = -40°C              | Normal operation | Square wave input       |      | 5.2  | 7.7  | μA   |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 5.2  | 7.7  |      |
|                          |                  |                |                                  | f <sub>SUB</sub> = 32.768 kHz Note 4<br>TA = +25°C              | Normal operation | Square wave input       |      | 5.3  | 7.7  |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 5.3  | 7.7  |      |
|                          |                  |                |                                  | f <sub>SUB</sub> = 32.768 kHz Note 4<br>TA = +50°C              | Normal operation | Square wave input       |      | 5.5  | 10.6 |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 5.5  | 10.6 |      |
|                          |                  |                |                                  | f <sub>SUB</sub> = 32.768 kHz Note 4<br>TA = +70°C              | Normal operation | Square wave input       |      | 5.9  | 13.2 |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 6.0  | 13.2 |      |
|                          |                  |                |                                  | f <sub>SUB</sub> = 32.768 kHz Note 4<br>TA = +85°C              | Normal operation | Square wave input       |      | 6.8  | 17.5 |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 6.9  | 17.5 |      |
|                          |                  |                |                                  | f <sub>SUB</sub> = 32.768 kHz Note 4<br>TA = +105°C             | Normal operation | Square wave input       |      | 15.5 | 77.8 |      |
|                          |                  |                |                                  |   |                  | Resonator connection    |      | 15.5 | 77.8 |      |

(Notes and Remarks are listed on the next page.)

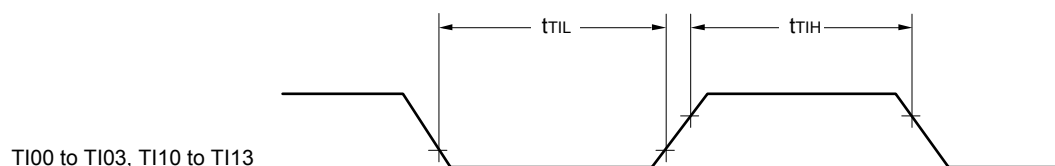
## AC Timing Test Points



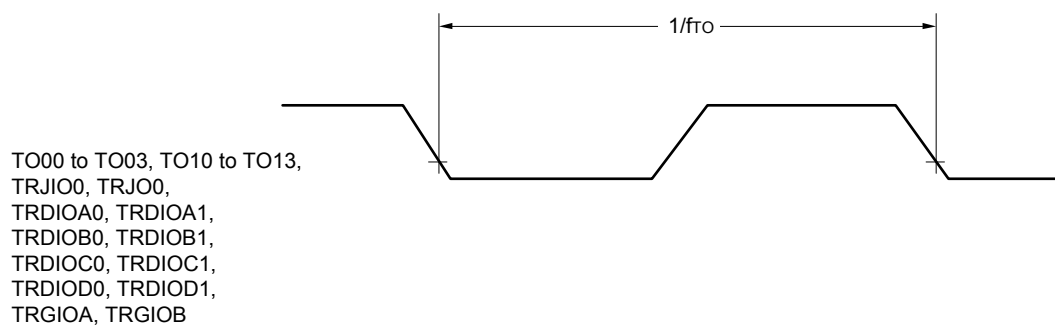
## External System Clock Timing



## TI/TO Timing



TI00 to TI03, TI10 to TI13



TO00 to TO03, TO10 to TO13,  
TRJIO0, TRJO0,  
TRDIOA0, TRDIOA1,  
TRDIOB0, TRDIOB1,  
TRDIOC0, TRDIOC1,  
TRDIOD0, TRDIOD1,  
TRGIOA, TRGIOB

**(2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output)****(TA = -40 to +105°C, 2.4 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)**

| Parameter                                  | Symbol                              | Conditions                             | HS (high-speed main) mode |      | Unit |
|--|-------------------------------------|--|---------------------------|------|------|
|  |                                     |  | MIN.                      | MAX. |      |
| SCKp cycle time                            | t <sub>KCY1</sub>                   | t <sub>KCY1</sub> ≥ 4/f <sub>CLK</sub> | 250                       |      | ns   |
|  |                                     | 2.7 V ≤ EVDD0 ≤ 5.5 V                  | 500                       |      | ns   |
| SCKp high-/low-level width                 | t <sub>KH1</sub> , t <sub>KL1</sub> | 4.0 V ≤ EVDD0 ≤ 5.5 V                  | t <sub>KCY1</sub> /2 - 24 |      | ns   |
|  |                                     | 2.7 V ≤ EVDD0 ≤ 5.5 V                  | t <sub>KCY1</sub> /2 - 36 |      | ns   |
|  |                                     | 2.4 V ≤ EVDD0 ≤ 5.5 V                  | t <sub>KCY1</sub> /2 - 76 |      | ns   |
| Slp setup time (to SCKp↑) Note 1           | t <sub>SIK1</sub>                   | 4.0 V ≤ EVDD0 ≤ 5.5 V                  | 66                        |      | ns   |
|  |                                     | 2.7 V ≤ EVDD0 ≤ 5.5 V                  | 66                        |      | ns   |
|  |                                     | 2.4 V ≤ EVDD0 ≤ 5.5 V                  | 113                       |      | ns   |
| Slp hold time (from SCKp↑) Note 2          | t <sub>KSI1</sub>                   |  | 38                        |      | ns   |
| Delay time from SCKp↓ to SOp output Note 3 | t <sub>KSO1</sub>                   | C = 30 pF Note 4                       |                           | 50   | ns   |

**Note 1.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp setup time becomes "to SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**Note 2.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**Note 3.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**Note 4.** C is the load capacitance of the SCKp and SOp output lines.

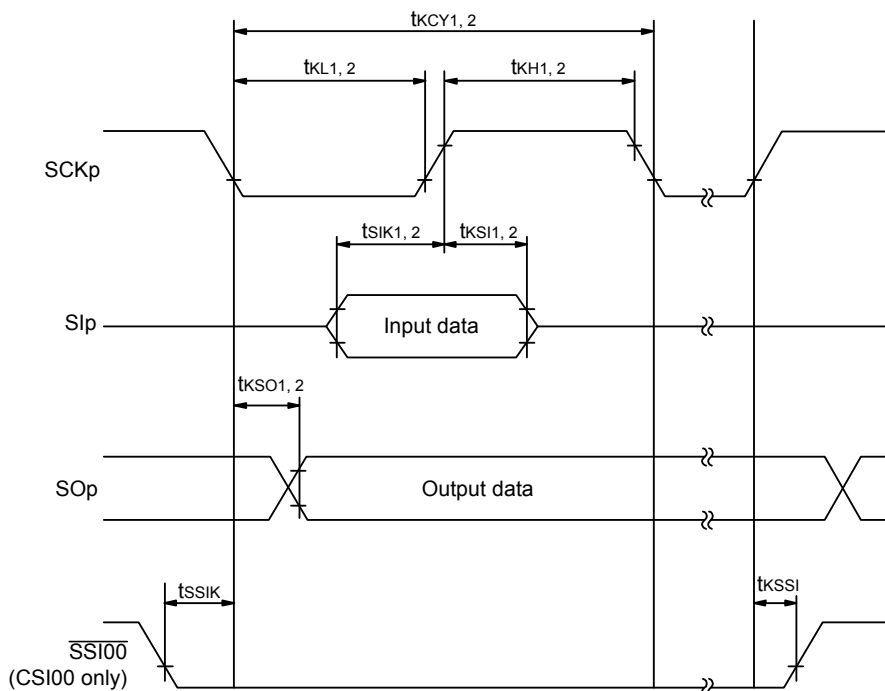
**Caution** Select the normal input buffer for the Slp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

**Remark 1.** p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3), g: PIM number (g = 0, 1, 3 to 5, 14)

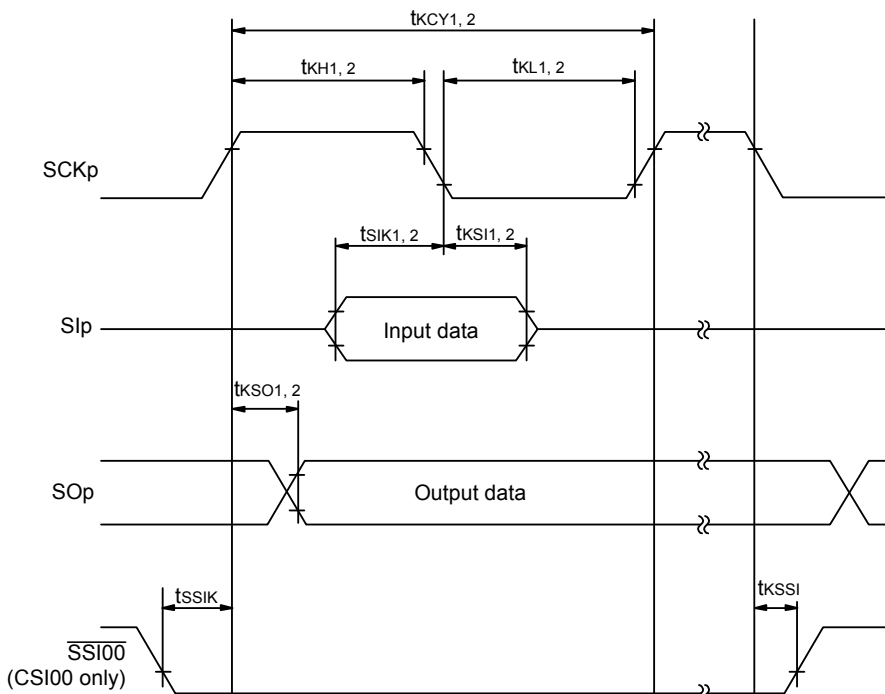
**Remark 2.** f<sub>MCK</sub>: Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))



**CSI mode serial transfer timing (during communication at same potential)**  
**(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)**



**CSI mode serial transfer timing (during communication at same potential)**  
**(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)**



**Remark 1.** p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31)

**Remark 2.** m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13)

**(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified I<sup>2</sup>C mode)****( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq \text{EVDD0} = \text{EVDD1} \leq \text{VDD} \leq 5.5\text{ V}$ ,  $\text{VSS} = \text{EVSS0} = \text{EVSS1} = 0\text{ V}$ )****(2/2)**

| Parameter                     | Symbol              | Conditions  | HS (high-speed main) mode       |      | Unit |
|-------------------------------|---------------------|---|---------------------------------|------|------|
|                               |                     |   | MIN.                            | MAX. |      |
| Data setup time (reception)   | $t_{\text{SU:DAT}}$ | $4.0\text{ V} \leq \text{EVDD0} \leq 5.5\text{ V}$ ,<br>$2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ ,<br>$C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$  | $1/f_{\text{MCK}} + 340$ Note 2 |      | ns   |
|                               |                     | $2.7\text{ V} \leq \text{EVDD0} < 4.0\text{ V}$ ,<br>$2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ ,<br>$C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$     | $1/f_{\text{MCK}} + 340$ Note 2 |      | ns   |
|                               |                     | $4.0\text{ V} \leq \text{EVDD0} \leq 5.5\text{ V}$ ,<br>$2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ ,<br>$C_b = 100\text{ pF}$ , $R_b = 2.8\text{ k}\Omega$ | $1/f_{\text{MCK}} + 760$ Note 2 |      | ns   |
|                               |                     | $2.7\text{ V} \leq \text{EVDD0} < 4.0\text{ V}$ ,<br>$2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ ,<br>$C_b = 100\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$    | $1/f_{\text{MCK}} + 760$ Note 2 |      | ns   |
|                               |                     | $2.4\text{ V} \leq \text{EVDD0} < 3.3\text{ V}$ ,<br>$1.6\text{ V} \leq V_b \leq 2.0\text{ V}$ ,<br>$C_b = 100\text{ pF}$ , $R_b = 5.5\text{ k}\Omega$    | $1/f_{\text{MCK}} + 570$ Note 2 |      | ns   |
| Data hold time (transmission) | $t_{\text{HD:DAT}}$ | $4.0\text{ V} \leq \text{EVDD0} \leq 5.5\text{ V}$ ,<br>$2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ ,<br>$C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$  | 0                               | 770  | ns   |
|                               |                     | $2.7\text{ V} \leq \text{EVDD0} < 4.0\text{ V}$ ,<br>$2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ ,<br>$C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$     | 0                               | 770  | ns   |
|                               |                     | $4.0\text{ V} \leq \text{EVDD0} \leq 5.5\text{ V}$ ,<br>$2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ ,<br>$C_b = 100\text{ pF}$ , $R_b = 2.8\text{ k}\Omega$ | 0                               | 1420 | ns   |
|                               |                     | $2.7\text{ V} \leq \text{EVDD0} < 4.0\text{ V}$ ,<br>$2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ ,<br>$C_b = 100\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$    | 0                               | 1420 | ns   |
|                               |                     | $2.4\text{ V} \leq \text{EVDD0} < 3.3\text{ V}$ ,<br>$1.6\text{ V} \leq V_b \leq 2.0\text{ V}$ ,<br>$C_b = 100\text{ pF}$ , $R_b = 5.5\text{ k}\Omega$    | 0                               | 1215 | ns   |

**Note 1.** The value must also be equal to or less than  $f_{\text{MCK}}/4$ .**Note 2.** Set the  $f_{\text{MCK}}$  value to keep the hold time of  $\text{SCLr} = \text{"L"}$  and  $\text{SCLr} = \text{"H"}$ .

**Caution** Select the TTL input buffer and the N-ch open drain output ( $\text{VDD}$  tolerance (for the 30- to 52-pin products)/ $\text{EVDD}$  tolerance (for the 64- to 100-pin products)) mode for the  $\text{SDAr}$  pin and the N-ch open drain output ( $\text{VDD}$  tolerance (for the 30- to 52-pin products)/ $\text{EVDD}$  tolerance (for the 64- to 100-pin products)) mode for the  $\text{SCLr}$  pin by using port input mode register g (PIMg) and port output mode register g (POMg). For  $V_{\text{IH}}$  and  $V_{\text{IL}}$ , see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the next page.)

### 3.6.4 Comparator

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq \text{EVDD0} = \text{EVDD1} \leq \text{VDD} \leq 5.5\text{ V}$ ,  $\text{VSS} = \text{EVSS0} = \text{EVSS1} = 0\text{ V}$ )

| Parameter                                 | Symbol | Conditions   | MIN. | TYP.              | MAX.                 | Unit          |
|---|--------|--|------|-------------------|----------------------|---------------|
| Input voltage range                       | Ivref  |  | 0    |                   | $\text{EVDD0} - 1.4$ | V             |
|   | Ivcmp  |  | -0.3 |                   | $\text{EVDD0} + 0.3$ | V             |
| Output delay                              | td     | $\text{VDD} = 3.0\text{ V}$<br>Input slew rate $> 50\text{ mV}/\mu\text{s}$<br>Comparator high-speed mode, standard mode |      |                   | 1.2                  | $\mu\text{s}$ |
|   |        | Comparator high-speed mode, window mode  |      |                   | 2.0                  | $\mu\text{s}$ |
|   |        | Comparator low-speed mode, standard mode   |      | 3.0               | 5.0                  | $\mu\text{s}$ |
| High-electric-potential reference voltage | VTW+   | Comparator high-speed mode, window mode  |      | $0.76\text{ VDD}$ |                      | V             |
| Low-electric-potential reference voltage  | VTW-   | Comparator high-speed mode, window mode  |      | $0.24\text{ VDD}$ |                      | V             |
| Operation stabilization wait time         | tcMP   |  | 100  |                   |                      | $\mu\text{s}$ |
| Internal reference voltage<br>Note        | VBGR   | $2.4\text{ V} \leq \text{VDD} \leq 5.5\text{ V}$ , HS (high-speed main) mode   | 1.38 | 1.45              | 1.50                 | V             |

**Note** Not usable in sub-clock operation or STOP mode.

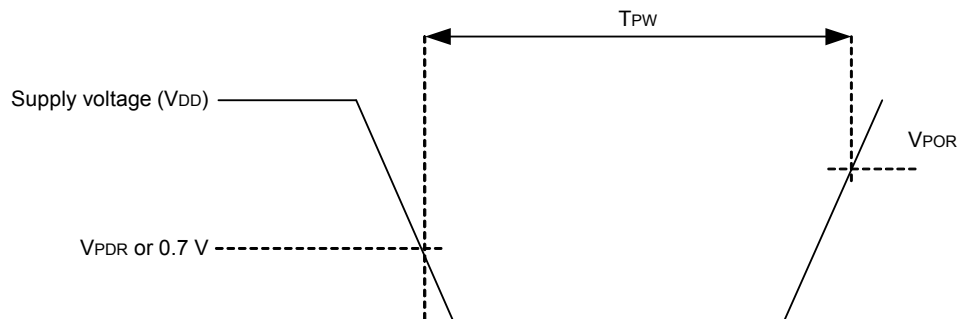
### 3.6.5 POR circuit characteristics

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $\text{VSS} = 0\text{ V}$ )

| Parameter                     | Symbol | Conditions                                       | MIN. | TYP. | MAX. | Unit          |
|-------------------------------|--------|--|------|------|------|---------------|
| Power on/down reset threshold | VPOR   | Voltage threshold on $\text{VDD}$ rising         | 1.45 | 1.51 | 1.57 | V             |
|                               | VPDR   | Voltage threshold on $\text{VDD}$ falling Note 1 | 1.44 | 1.50 | 1.56 | V             |
| Minimum pulse width Note 2    | TPW    |  | 300  |      |      | $\mu\text{s}$ |

**Note 1.** However, when the operating voltage falls while the LVD is off, enter STOP mode, or enable the reset status using the external reset pin before the voltage falls below the operating voltage range shown in 3.4 AC Characteristics.

**Note 2.** Minimum time required for a POR reset when  $\text{VDD}$  exceeds below  $\text{VPDR}$ . This is also the minimum time required for a POR reset from when  $\text{VDD}$  exceeds below  $0.7\text{ V}$  to when  $\text{VDD}$  exceeds  $\text{VPOR}$  while STOP mode is entered or the main system clock is stopped through setting bit 0 (HIOSTOP) and bit 7 (MSTOP) in the clock operation status control register (CSC).



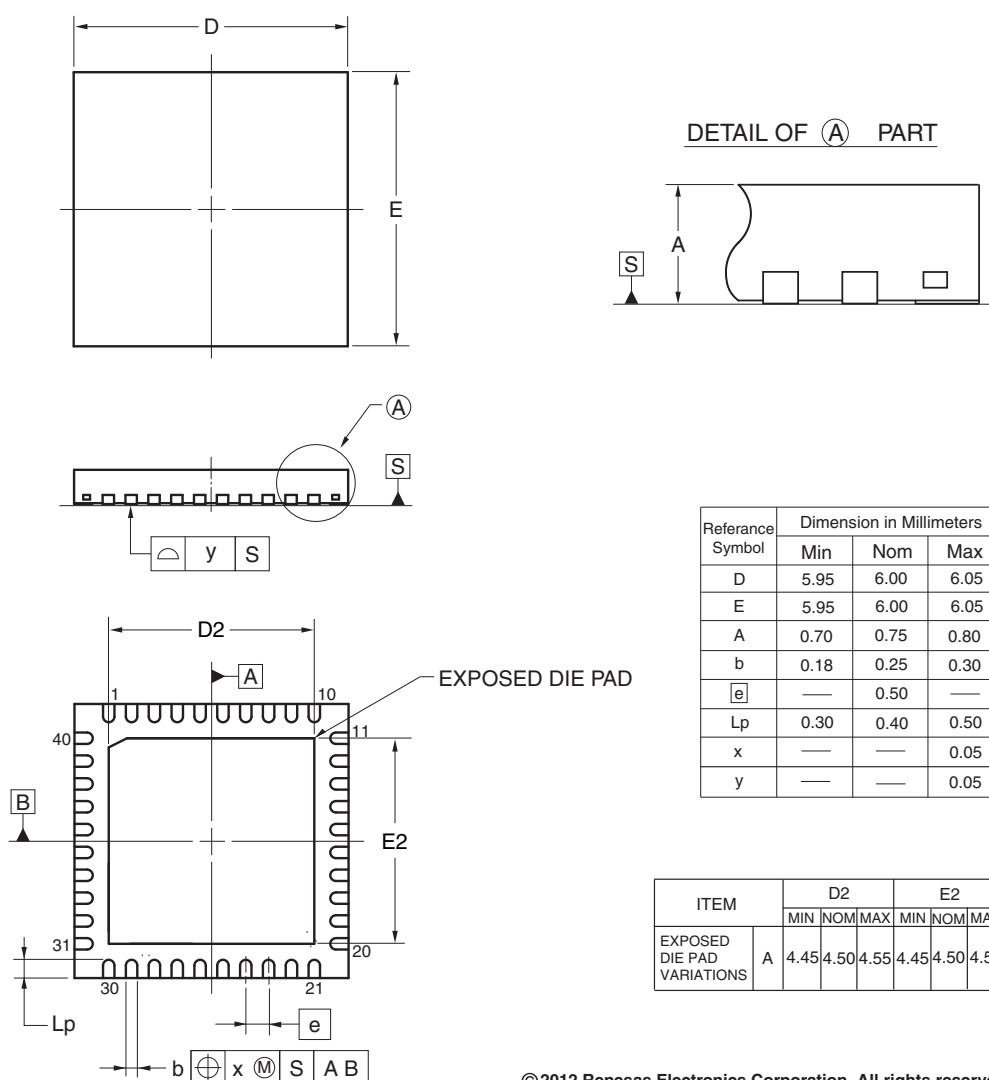
#### 4.4 40-pin products

R5F104EAANA, R5F104ECANA, R5F104EDANA, R5F104EEANA, R5F104EFANA, R5F104EGANA, R5F104EHANA

R5F104EADNA, R5F104ECDNA, R5F104EDDNA, R5F104EEDNA, R5F104EFDNA, R5F104EGDNA, R5F104EHDNA

R5F104EAGNA, R5F104ECGNA, R5F104EDGNA, R5F104EEGNA, R5F104EFGNA, R5F104EGGNA, R5F104EHGNA

| JEITA Package Code | RENESAS Code | Previous Code  | MASS (TYP.) [g] |
|--------------------|--------------|----------------|-----------------|
| P-HWQFN40-6x6-0.50 | PWQN0040KC-A | P40K8-50-4B4-4 | 0.09            |



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|                  |                    |
|------------------|--------------------|
| REVISION HISTORY | RL78/G14 Datasheet |
|------------------|--------------------|

| Rev. | Date         | Description                             |  |
|------|--------------|---|--|
|      |              | Page                                    | Summary  |
| 3.20 | Jan 05, 2015 | p.135, 137, 139, 141, 143, 145<br>p.197 | Modification of specifications in 3.3.2 Supply current characteristics<br><br>Modification of part number in 4.7 52-pin products |
| 3.30 | Aug 12, 2016 | p.143, 145                              | Addition of maximum values in (3) Flash ROM: 384 to 512 KB of 48- to 100-pin products of 3.3.2 Supply current characteristics    |

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